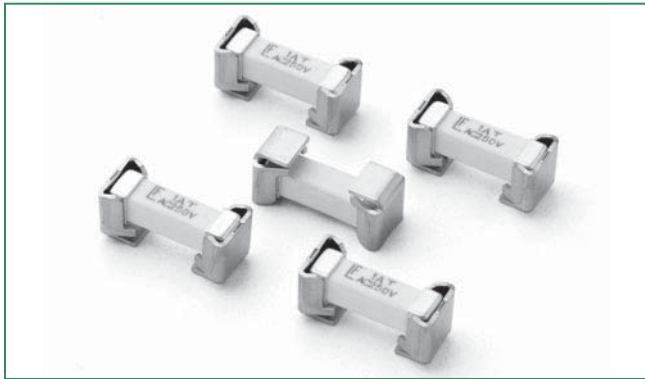


### RoHS HF 160 Series Fuse and Clip Assembly




#### Description

The 160 Series product is a metal fuse clip with pre-installed Littelfuse 443 Series Fuse. This fuse and clip combination can be automatically installed in PC Boards in one efficient manufacturing operation. It permits quick and easy fuse replacement without exposing the PC Boards and other components to risks of rework solder heat as required with direct surface mount fuses.

It is designed to enable compliance with the RoHS directive. This product is fully compatible with lead-free solder alloy and higher temperature profiles associated with lead-free assembly.

#### Agency Approvals

| AGENCY  | AGENCY FILE NUMBER | AMPERE RANGE |
|---|--------------------|--------------|
|  | E14721             | 0.5A - 5A    |

#### Electrical Characteristics for Series

| % of Ampere Rating | Opening Time         |
|--------------------|----------------------|
| 100%               | 4 hours, Minimum     |
| 250%               | 120 seconds, Maximum |


#### Features

- Offer low profile easily-replaceable fuse alternative compatible with automated PCB surface mount equipment
- Come supplied with Littelfuse 443 Series Time-Lag 250V Nano<sup>2</sup>® Fuse
- RoHS compliant and Halogen Free
- Clip fully compatible with RoHS/lead-free solder alloys and higher temperature profiles associated with lead-free assembly
- 0.5A - 5A ampere rating available

#### Applications

- AC/DC power adaptor
- Telecom equipment system power
- Portable system built-in AC/DC converter
- High voltage DC/DC converter
- Lighting System
- LED Lighting

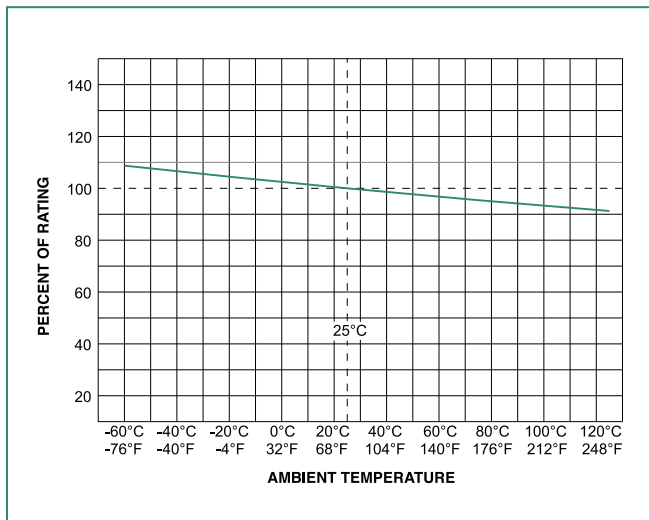
#### Electrical Specifications by Item

| Ampere Rating (A) | Amp Code | Max Voltage Rating (V) | Interrupting Rating | Nominal Cold Resistance (Ohms) | Nominal Melting I <sup>2</sup> t (A <sup>2</sup> sec) | Nominal Voltage Drop (mV) | Agency Approvals  |
|-------------------|----------|------------------------|---------------------|--------------------------------|---|---------------------------|---|
|                   |          |                        |                     |                                |   |                           |  |
| 0.50              | 0.50     | 250                    | 50 A @ 250 VAC      | .5974                          | 1.96  | 334                       | X   |
| 0.75              | 0.75     | 250                    |                     | .2729                          | 2.25  | 223                       | X   |
| 1.00              | 001.     | 250                    |                     | .1826                          | 9.00  | 207                       | X   |
| 1.50              | 01.5     | 250                    |                     | .1100                          | 15.21   | 210                       | X   |
| 2.00              | 002.     | 250                    |                     | .0511                          | 18.50   | 117                       | X   |
| 2.50              | 02.5     | 250                    |                     | .0392                          | 22.20   | 156                       | X   |
| 3.00              | 003.     | 250                    |                     | .0276                          | 59.29   | 103                       | X   |
| 3.50              | 03.5     | 250                    |                     | .0199                          | 59.34   | 87                        | X   |
| 4.00              | 004.     | 250                    |                     | .0160                          | 68.10   | 83                        | X   |
| 5.00              | 005.     | 250                    |                     | .0115                          | 122.39  | 73                        | X   |

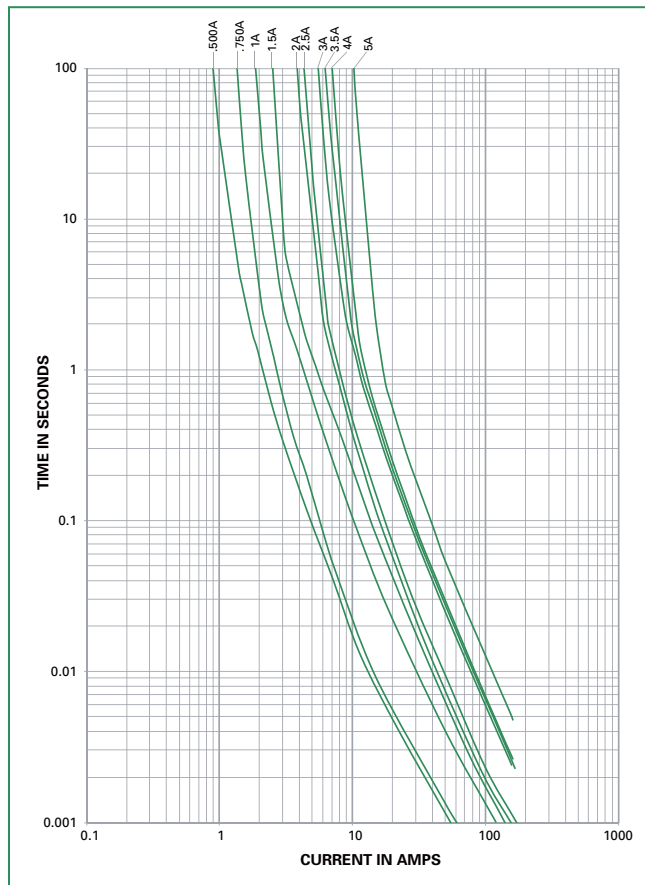
#### Notes:

1. Cold resistance measured at less than 10% of rated current at 23°C.
2. Agency Approval Table Key: X=Approved or Certified, P=Pending.

### Temperature Derating Curve

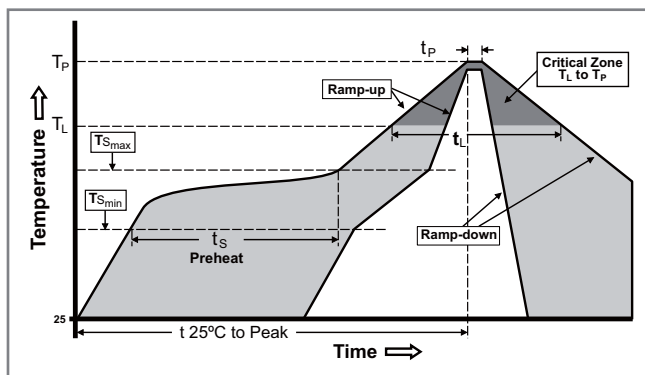


### Average Time Current Curves



### Soldering Parameters

|  |                                    |                  |
|--|------------------------------------|------------------|
| Reflow Condition                                       | Pb-free assembly                   |                  |
| Pre Heat   | - Temperature Min ( $T_{s(min)}$ ) | 150°C            |
|  | - Temperature Max ( $T_{s(max)}$ ) | 200°C            |
|  | - Time (Min to Max) ( $t_s$ )      | 60 – 180 seconds |
| Average Ramp-up Rate (Liquidus Temp ( $T_L$ ) to peak) | 5°C/second max.                    |                  |
| $T_{s(max)}$ to $T_L$ - Ramp-up Rate                   | 5°C/second max.                    |                  |
| Reflow   | - Temperature ( $T_L$ ) (Liquidus) | 217°C            |
|  | - Temperature ( $t_L$ )            | 60 – 150 seconds |
| Peak Temperature ( $T_p$ )                             | 250 <sup>+0/-5</sup> °C            |                  |
| Time within 5°C of actual peak Temperature ( $t_p$ )   | 20 – 40 seconds                    |                  |
| Ramp-down Rate   | 5°C/second max.                    |                  |
| Time 25°C to peak Temperature ( $T_p$ )                | 8 minutes max.                     |                  |
| Do not exceed  | 260°C                              |                  |

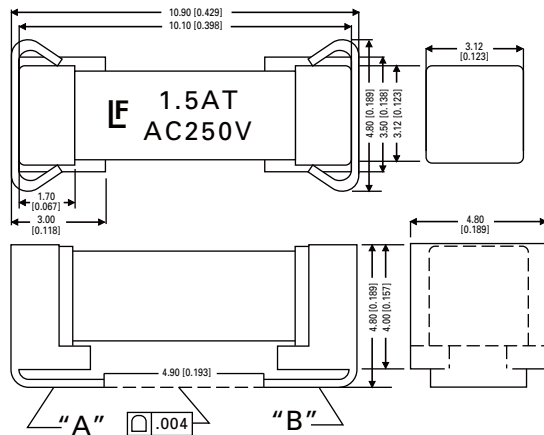


**Product Characteristics**

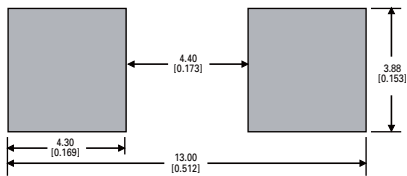
|  |  |
|--|--|
| <b>Materials</b>                             | <b>Body:</b> Ceramic<br><b>Cap:</b> Silver-plated Brass          |
| <b>Product Marking</b>                       | Brand, Ampere Rating, Voltage Rating, UMF Logo                   |
| <b>Insulation Resistance (after Opening)</b> | MIL-STD-202, Method 302, Test Condition A (10,000 ohms, Minimum) |
| <b>Solderability</b>                         | MIL-STD-202, Method 208  |
| <b>Resistance to Soldering Heat</b>          | MIL-STD-202, Method 210, Test Condition B (10 seconds at 260°C)  |
| <b>Moisture Sensitivity Level</b>            | Level 1 J-STD-020C   |

|                              |  |
|------------------------------|--|
| <b>Operating Temperature</b> | -55°C to 125°C with proper derating                                    |
| <b>Thermal Shock</b>         | MIL-STD-202F, Method 107G, Test Condition B (5 cycles, -65°C to 125°C) |
| <b>Vibration</b>             | MIL-STD-202F, Method 201A (10-55 Hz)                                   |
| <b>Moisture Resistance</b>   | MIL-STD-202, Method 106, High Humidity (90-98%RH), Heat (65°C)         |
| <b>Salt Spray</b>            | MIL-STD-202F, Method 101D, Test Condition B                            |
| <b>Mechanical Shock</b>      | MIL-STD-202, Method 213, Test Condition I (100 G's peak for 6 msec.)   |

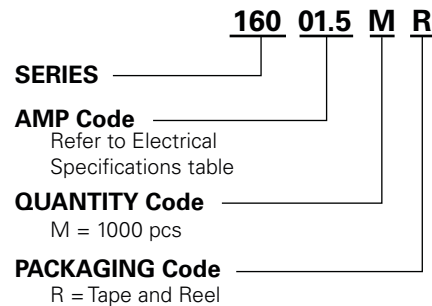
**Dimensions**



Recommended Pad Layout



**Part Numbering System**



**Example:**  
1.5 amp product is 016001.5 MR

**Packaging**

| Form Factor   | Packaging Option   | Packaging Specification        | Quantity | Quantity & Packaging Code |
|---------------|--------------------|--------------------------------|----------|---------------------------|
| Surface Mount | 24mm Tape and Reel | EIA-RS 481-2 (IEC 286, part 3) | 1000     | MR                        |

